

US1AW THRU US1MW

Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case:SOD-123FL
- Terminals: Solderable per MIL-STD-750, Method 20
- Approx. Weight: 15mg/0.00053oz



Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	US1AW	US1BW	US1DW	US1GW	US1JW	US1KW	US1MW	Units			
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V			
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V			
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V			
Maximum Average Forward Rectified Current at $T_c = 125^\circ C$	$I_{F(AV)}$	1						A				
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	30						A				
Maximum Instantaneous Forward Voltage at 1 A	V_F	1.0		1.3	1.65			V				
Maximum DC Reverse Current $T_a = 25^\circ C$ at Rated DC Blocking Voltage $T_a = 125^\circ C$	I_R	5 100						μA				
Maximum Reverse Recovery Time ⁽¹⁾	trr	50		75			ns					
Typical Junction Capacitance ⁽²⁾	C_j	15						pF				
Typical Thermal Resistance ⁽³⁾	$R_{\theta JA}$	85						$^\circ C/W$				
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150						$^\circ C$				

(1) Measured with $IF = 0.5 A$, $IR = 1 A$, $Irr = 0.25 A$

(2) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(3) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas

Rating And Characteristic Curves

Fig.1 Forward Current Derating Curve

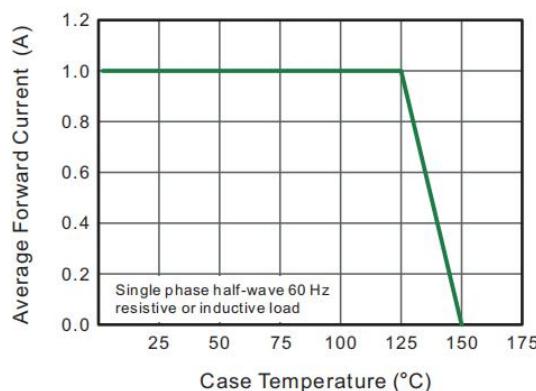


Fig.2 Typical Reverse Characteristics

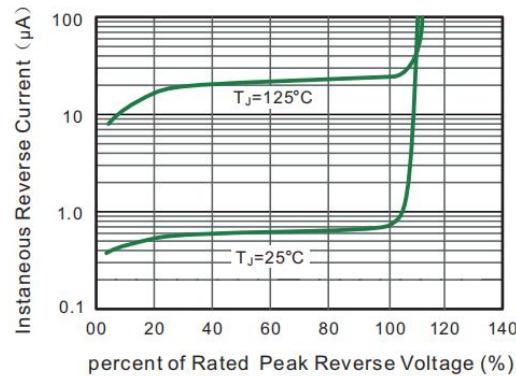


Fig.3 Typical Forward Characteristics

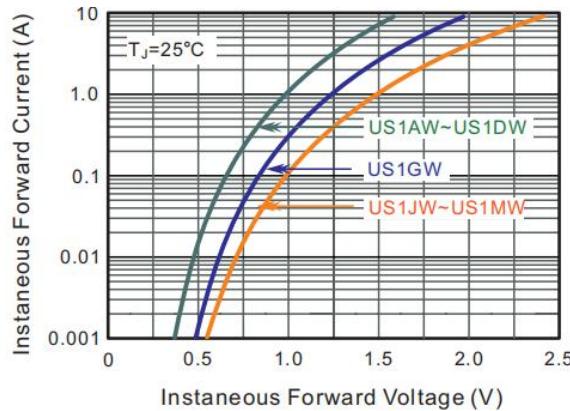


Fig.4 Maximum Non-Repetitive Peak

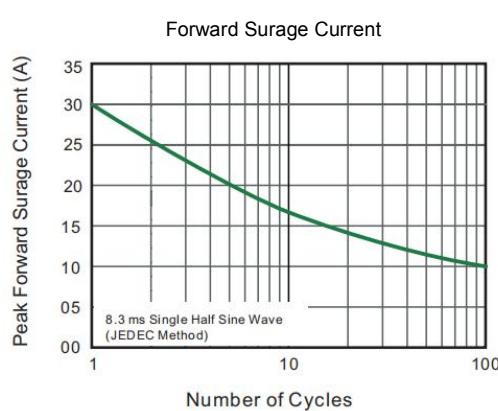


Fig.5 Typical Junction Capacitance

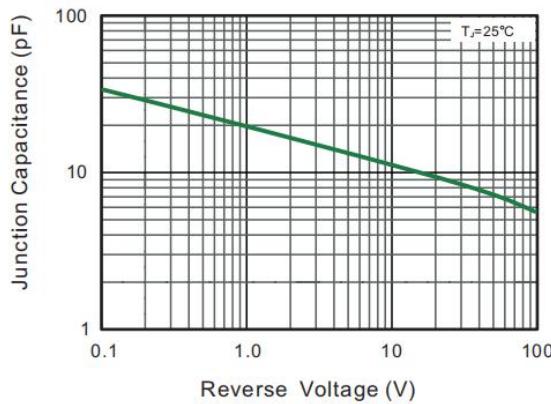
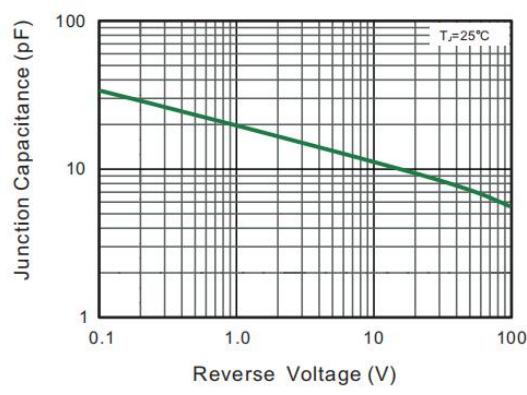


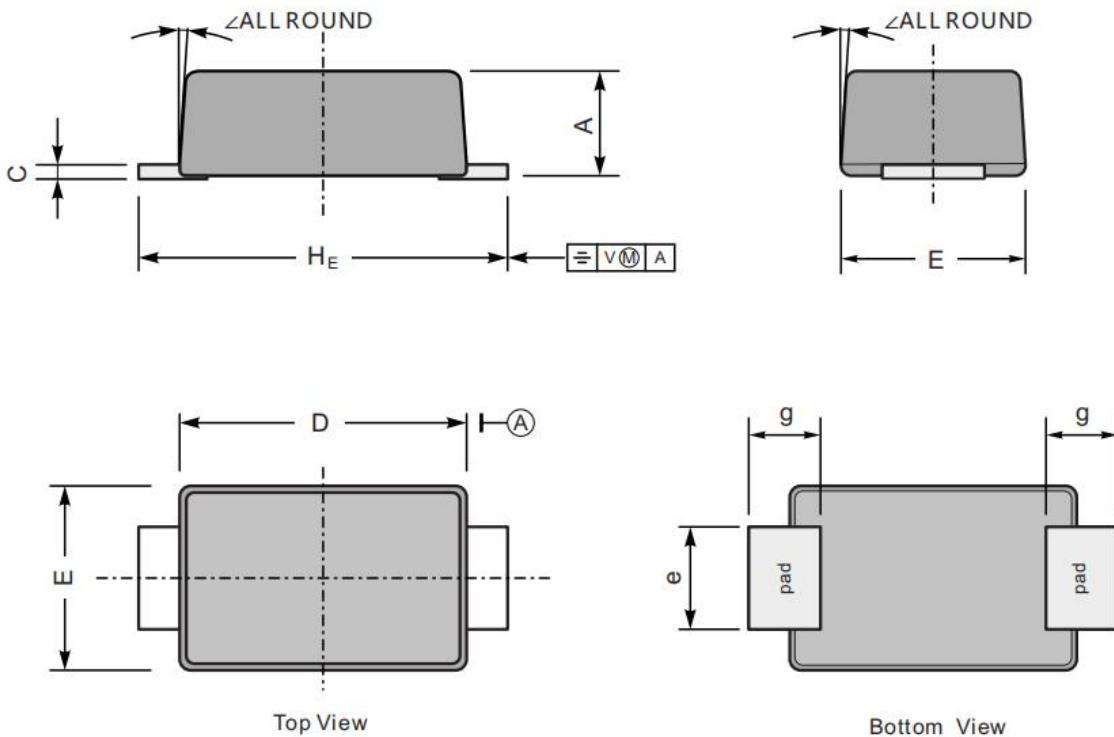
Fig.6 Typical Junction Capacitance



Package Outline

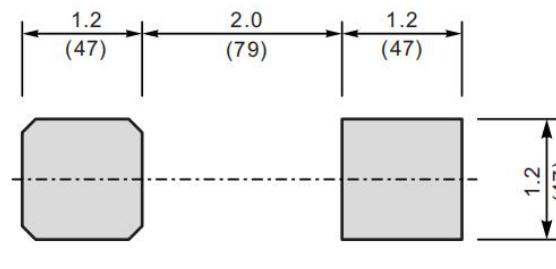
Plastic surface mounted package; 2 leads

SOD-123FL



UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.1	0.2	2.9	1.9	1.1	0.9	3.8	7°
	min	0.9	0.12	2.6	1.7	0.8	0.7	3.5	
mil	max	43	7.9	114	75	43	35	150	7°
	min	35	4.7	102	67	31	28	138	

The recommended mounting pad size


 Unit: $\frac{\text{mm}}{(\text{mil})}$